# **Tyrone Camarero Specifications**



## Camarero-SDI200A2N-28

## **Key Feature**

Virtualization, Software-defined Storage, Al Inference and Machine Learning, Cloud Computing, Enterprise Server

- "Dual Socket E (LGA-4677), 5th Gen Intel® Xeon® / 4th Gen Intel® Xeon® Scalable processors, Supports Intel Xeon CPU Max Series with high bandwidth memory (HBM)"
- 32 DIMM slots, Max Memory (1DPC): Up to 4TB 5600MT/s ECC DDR5 RDIMM, Max Memory (2DPC): Up to 8TB 4400MT/s ECC DDR5 RDIMM
- "Optional PCIe slot configurations up to 8 PCIe 5.0 x8 or 4 PCIe 5.0 x16 slots with support for double-width GPU/Accelerator cards"
- Flexible networking options with up to 2 AIOM networking slots (OCP NIC 3.0 compatible)
- 8x 2.5" hot-swap NVMe/SATA/SAS drive bays;, Optional 8x 2.5" hot-swap NVMe/SAS/SATA drive bays;, 2x internal M.2 NVMe/SATA drive slots; Optional RAID support via storage add-
- 4 heavy duty hot-swap fans with optimal fan speed control
- 2x 1200W Redundant Titanium Level power supplies





#### Processor/Cache

Processor Dual Socket E (LGA-4677), 5th Gen Intel® Xeon® /

4th Gen Intel® Xeon® Scalable

processors,Supports Intel Xeon CPU Max Series with high bandwidth memory (HBM) "
Note: Supports up to 350W TDP CPUs
(Air Cooled), Supports up tp 350W TDP CPUs

(Liquid-Cooled)

#### Chipset

Chipset Intel® C741 Chipset

#### System Memory

Memory Capacity 32 DIMM slots, Max Memory (1DPC): Up to 4TB 5600MT/s ECC DDR5 RDIMM, Max Memory (2DPC): Up to 8TB 4400MT/s ECC DDR5

RDIMM

#### **Expansion Slots**

PCI-Express

4 (Optional) PCle 5.0 x16 or x8 FH, 10.5"L slot(s), 4 (Optional) PCle 5.0 x8 FH, 10.5"L

slot(s) slot(s)

## Integrated On-Board

Network Connectivity 2x 1GbE BaseT with Intel® i350-AM2 (optional), 4x 1GbE BaseT or 4x 1GbE SFP with Intel® i350-AM4 (optional), 2 x 10GbE BaseT with Intel® X550-AT2 (optional), 2x 10GbE SFP+ with Intel® X710-BM2 (optional), 4x 10GbE SFP+ with Intel® X710-BM1 (optional), 4x 10GbE SFP+ with Intel® X710-BM1 (optional), 4x 10GbE SFP+ with Intel® X710-TM4 (optional), 2x 25GbE SFP28 with Broadcom® BCM57414 (optional), 4x 25GbE RJ45/SFP28 with Mellanox® CX-4 Lx EN Intel® X550-AT2 (optional), 2x 100GbE QSFP28 with Broadcom® BCM57508 (optional)

IPMI Support for Intelligent Platform Management Interface v.2.0, IPMI 2.0 with virtual media

#### Add-on Options

Raid card Optional

Optical Drive None

## Front Panel

LED HDD activity, LAN1 activity, Power

status, System information

**Buttons** Power On/Off, Universal Information

(UID)

## Drive bays

Drive bays

8x 2.5" hot-swap NVMe/SATA/SAS drive

bays (Configurable option for 16x 2.5" hot-swap NVMe/SAS/SATA drive bays. NVMe, SATA, or SAS support requires additional parts, 2 M.2 NVMe OR 2 M.2 SATA3, M-Key, 2280/2210adding 1x AOC-S3908L-H8IR-16DD-0), 2 M.2 NVMe

#### **Power Supply**

**Power Supply** 

2x 1200W Redundant Titanium Level power

supplies

## **Cooling System**

Fans 4x 8cm heavy duty fans with optimal fan

speed control, 2 Air Shroud(s)

Liquid Cooling Direct to Chip (D2C) Cold Plate (optional)

## Form Factor

Form Factor 2U Rackmount

#### **Dimensions**

**Dimensions** Height - 3.5" (88.9mm), Width - 17.2"

(437mm), Depth - 29.9" (760mm)

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